Silicon NPN Triple Diffused

HITACHI

Application

Low frequency high voltage power amplifier TV vertical deflection output complementary pair with 2SB1530

Outline

TO-220FM		
	1. Boæ 2. Colleptar 3. Emitter	



Absolute Maximum Ratings (Ta = 25° C)

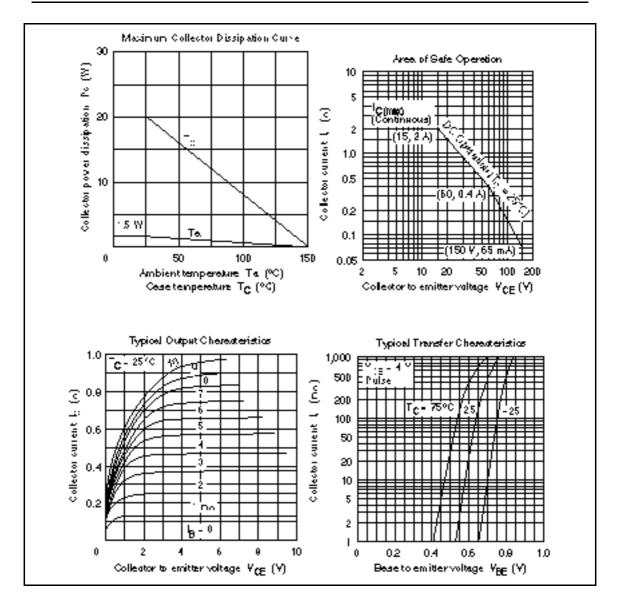
Item	Symbol	Ratings	Unit
Collector to base voltage	V _{CBO}	200	V
Collector to emitter voltage	V _{CEO}	150	V
Emitter to base voltage	V _{EBO}	6	V
Collector current	Ι _c	2	А
Collector peak current	I _{C(peak)}	5	А
Collector power dissipation	Pc	1.5	W
	P _c * ¹	20	
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-45 to +150	°C

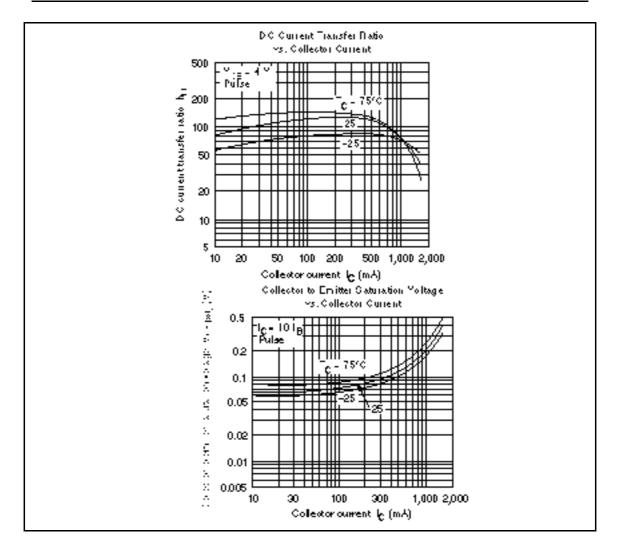
Note: 1. Value at $T_c = 25^{\circ}C$.

Electrical Characteristics (Ta = 25° C)

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to emitter breakdown voltage	$V_{(\text{BR})\text{CEO}}$	150	—	—	V	$I_{\rm C}$ = 50 mA, $R_{\rm BE}$ =
Emitter to base breakdown voltage	$V_{(\text{BR})\text{EBO}}$	6	_	_	V	$I_{\rm E} = 5$ mA, $I_{\rm C} = 0$
Collector cutoff current	I _{CBO}		—	1	μA	$V_{CB} = 120 \text{ V}, \text{ I}_{E} = 0$
DC current transfer ratio	h_{FE1}^{*1}	60	_	320		$V_{ce} = 4 \text{ V}, I_c = 50 \text{ mA}$
	h _{FE2}	60	_	—	—	V_{ce} = 10 V, I_c = 500 mA ^{*2}
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	—	—	3.0	V	$I_{c} = 500 \text{ mA}, I_{B} = 50 \text{ mA}^{*2}$
Base to emitter voltage	V_{BE}	_	_	1.0	V	$V_{ce} = 4 \text{ V}, \text{ I}_{c} = 50 \text{ mA}$
Notes: 1. The 2SD2337 is gro	ouped by h	FE1 as fo	llows.			
2. Pulse test.						
B C D						

60 to 120 100 to 200 160 to 320	
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Hitachi, Ltd. Semiconductor & IC DV. Nepon Bidg, 2-5-2, Ohte-mach, Chiyoda-ku, Tokyo 100, Japan Tet Tokyo (03, 3270-2111 Fax (03, 3270-5109

For Auther in forms Ion write to : Hischi America, Ud Semiconductor & IC DW. 2000 Sierre Point Perlavey Briebene, CA. 94005-4835 U S.Å Tet 415-583-8300 Fax 415-583-4207

Hitschi Burope GmbH Bedronic Components Group Cartinertal Burope Danscher Straße 3 D-85522 Fieldkirchen Minchen Tet 083-9 94 80-0 Fex 083-9 29 30 00 Hitschi Europe Ltd. Bectronic Components Div. Northern Burge Hesdguerters Whitsbrock Ferk Lower Cook hem Roed Neidenhesd Berkshire SL6SYA United Kingdom Tet 0628-355000 Fex 0628-778222 Hitschi Asia Pte. Ltd 45 Collyer Quey \$20-00 Hitschi Tower Singspore 0404 Tet 535-2400 Fex: 535-4533

Hitschi Asia (Hong Kong) Ltd. Unit 705, North Towar, World Finance Cantre, Herbour City, Carton Road Taim Sha Tau, Kowloon Hang Kong Tet 27:352218 Fax: 27:356074

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